

N-channel 30 V 11.6 mΩ logic level MOSFET in LFPAK using NextPower technology

Rev. 3 — 24 October 2011

**Product data sheet** 

### 1. Product profile

### 1.1 General description

Logic level enhancement mode N-channel MOSFET in LFPAK package. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

### **1.2 Features and benefits**

- High reliability Power SO8 package, qualified to 175°C
- Low parasitic inductance and resistance
- Optimised for 4.5V Gate drive utilising NextPower Superjunction technology
- Ultra low QG, QGD, & QOSS for high system efficiencies at low and high loads

### **1.3 Applications**

Quick reference data

Table 1.

- DC-to-DC converters
- Load switching

### Synchronous buck regulator

### 1.4 Quick reference data

	Quient reference data					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C	-	-	30	V
I <sub>D</sub>	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V}; \text{ see } \frac{\text{Figure 1}}{10000000000000000000000000000000000$	-	-	37	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	-	29	W
Tj	junction temperature		-55	-	175	°C
Static cha	racteristics					
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 4.5 V; $I_D$ = 10 A; $T_j$ = 25 °C; see <u>Figure 12</u>	-	12.3	14.5	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 10 \text{ A}; T_j = 25 \text{ °C};$ see <u>Figure 12</u>	-	9.9	11.6	mΩ
Dynamic	characteristics					
$Q_{GD}$	gate-drain charge	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 10 A; $V_{DS}$ = 15 V; see Figure 14; see Figure 15	-	1.4	-	nC
Q <sub>G(tot)</sub>	total gate charge	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 10 A; $V_{DS}$ = 15 V; see Figure 14; see Figure 15	-	4.9	-	nC

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#### **Pinning information** 2.

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		5
2	S	source	mb	
3	S	source		
4	G	gate		
mb	D	mounting base; connected to drain		mbb076 S

#### SOT669 (LFPAK; Power-SO8)

#### **Ordering information** 3.

Table 3.         Ordering information						
Type number	Package					
	Name	Description	Version			
PSMN011-30YLC	LFPAK; Power-SO8	plastic single-ended surface-mounted package; 4 leads	SOT669			

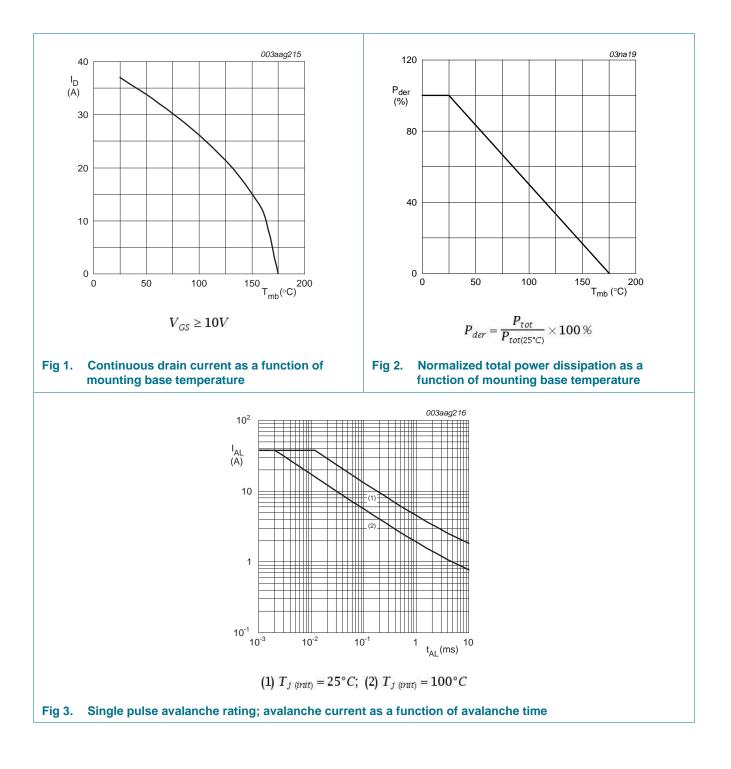
#### **Limiting values** 4.

#### Table 4. **Limiting values**

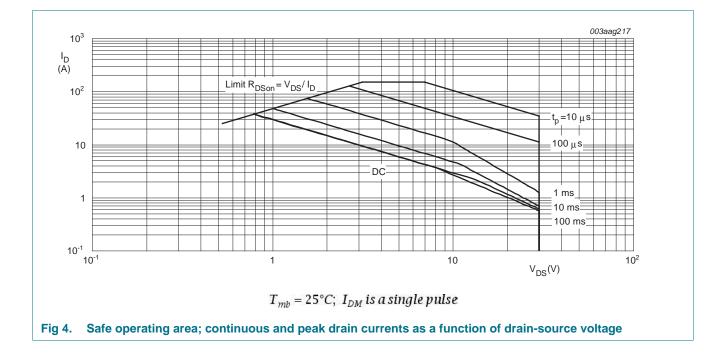
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C	-	30	V
V <sub>DGR</sub>	drain-gate voltage	25 °C $\leq$ T <sub>j</sub> $\leq$ 175 °C; R <sub>GS</sub> = 20 k $\Omega$	-	30	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	$V_{GS}$ = 10 V; $T_{mb}$ = 25 °C; see <u>Figure 1</u>	-	37	А
		$V_{GS}$ = 10 V; $T_{mb}$ = 100 °C; see <u>Figure 1</u>	-	26	А
I <sub>DM</sub>	peak drain current	pulsed; t <sub>p</sub> ≤ 10 µs; T <sub>mb</sub> = 25 °C; see <u>Figure 4</u>	-	150	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	29	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
T <sub>sld(M)</sub>	peak soldering temperature		-	260	°C
V <sub>ESD</sub>	electrostatic discharge voltage	MM (JEDEC JESD22-A115)	140	-	V
Source-drai	n diode				
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C	-	26	А
I <sub>SM</sub>	peak source current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^\circ C$	-	150	А
Avalanche r	uggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_D$ = 37 A; $V_{sup} \le 30$ V; $R_{GS}$ = 50 $\Omega$ ; unclamped; see Figure 3	-	9	mJ

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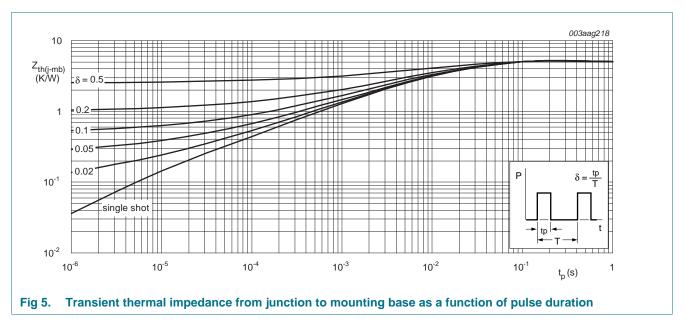
# PSMN011-30YLC



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#### **Thermal characteristics** 5.

Table 5.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	see Figure 5	-	4.87	5.06	K/W



### N-channel 30 V 11.6 mΩ logic level MOSFET in LFPAK using NextPower technology

### 6. Characteristics

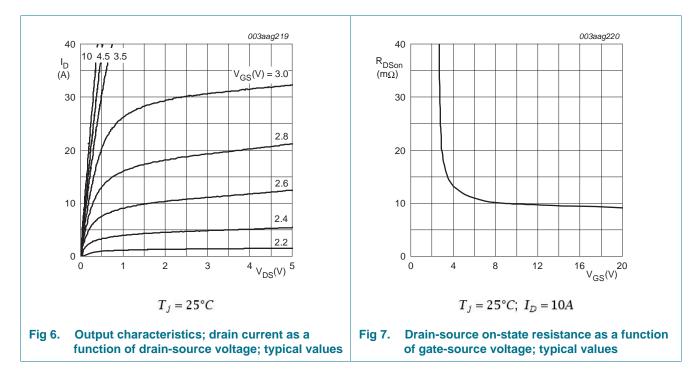
Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	30	-	-	V
	voltage	$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = -55 °C	27	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 10</u> ; see <u>Figure 11</u>	1.05	1.57	1.95	V
		$I_D = 10 \text{ mA}; V_{DS} = V_{GS}; T_j = 150 \text{ °C}$	0.5	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}$	-	-	2.25	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	1	μA
		$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	100	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 16 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
		$V_{GS}$ = -16 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 10 A; T <sub>j</sub> = 25 °C; see <u>Figure 12</u>	-	12.3	14.5	mΩ
		V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 10 A; T <sub>j</sub> = 150 °C; see <u>Figure 12</u> ; see <u>Figure 13</u>	-	-	23.4	mΩ
	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 10 A; T <sub>j</sub> = 25 °C; see <u>Figure 12</u>	-	9.9	11.6	mΩ	
	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 10 A; T <sub>j</sub> = 150 °C; see <u>Figure 12</u> ; see <u>Figure 13</u>	-	-	18.8	mΩ	
R <sub>G</sub>	gate resistance	f = 1 MHz	-	2	4	Ω
Dynamic	characteristics					
Q <sub>G(tot)</sub> total gate	total gate charge	$I_D = 10 \text{ A}; V_{DS} = 15 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 14</u> ; see <u>Figure 15</u>	-	10.3	-	nC
		$I_D = 10 \text{ A}; V_{DS} = 15 \text{ V}; V_{GS} = 4.5 \text{ V};$ see <u>Figure 14</u> ; see <u>Figure 15</u>	-	4.9	-	nC
		$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}$	-	9	-	nC
Q <sub>GS</sub>	gate-source charge	$I_D = 10 \text{ A}; V_{DS} = 15 \text{ V}; V_{GS} = 4.5 \text{ V};$	-	1.5	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate-source charge	see Figure 14; see Figure 15	-	1.1	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate-source charge		-	0.4	-	nC
Q <sub>GD</sub>	gate-drain charge		-	1.4	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	$I_D = 10 \text{ A}; V_{DS} = 15 \text{ V}; \text{ see } \frac{\text{Figure } 14}{\text{Figure } 15}$	-	2.5	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 15 V; V <sub>GS</sub> = 0 V; f = 1 MHz;	-	641	-	pF
C <sub>oss</sub>	output capacitance	$T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{100}$	-	146	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	46	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 15 V; $R_{L}$ = 0.6 $\Omega$ ; $V_{GS}$ = 4.5 V;	-	13.4	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 4.7 \ \Omega$	-	12.7	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	16.8	-	ns
t <sub>f</sub>	fall time			6.6		ns

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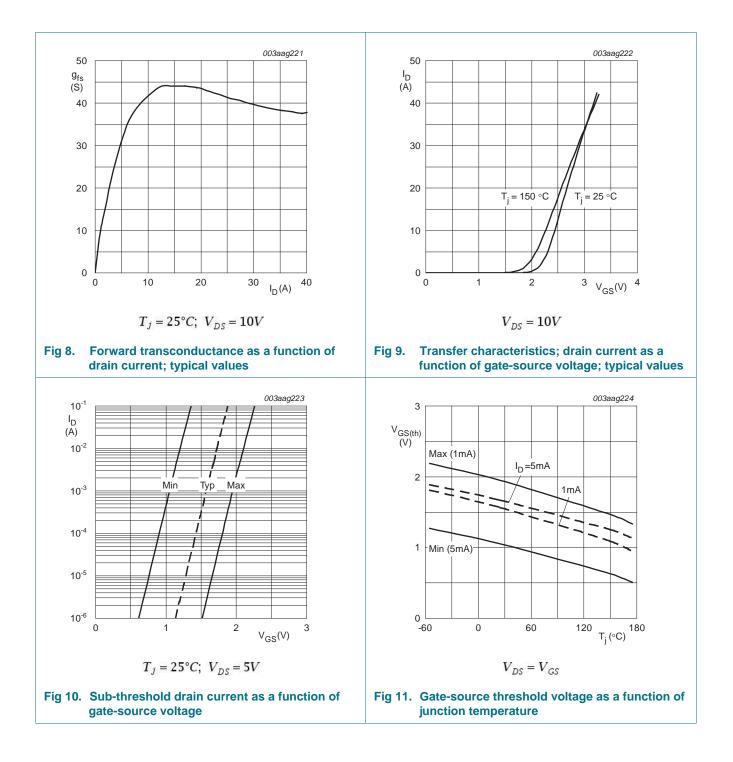
#### Table 6. Characteristics ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Q <sub>oss</sub>	output charge	$V_{GS}$ = 0 V; $V_{DS}$ = 15 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	3.8	-	nC
Source-dra	in diode					
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 10 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; see <u>Figure 17</u>	-	0.85	1.1	V
t <sub>rr</sub>	reverse recovery time	I <sub>S</sub> = 10 A; dI <sub>S</sub> /dt = -100 A/μs;	-	17	-	ns
Q <sub>r</sub>	recovered charge	$V_{GS} = 0 V; V_{DS} = 15 V$	-	7	-	nC
t <sub>a</sub>	reverse recovery rise time	V <sub>GS</sub> = 0 V; I <sub>S</sub> = 10 A;	-	10	-	ns
t <sub>b</sub>	reverse recovery fall time	dI <sub>S</sub> /dt = -100 A/µs; V <sub>DS</sub> = 15 V; see <u>Figure 18</u>	-	7	-	ns



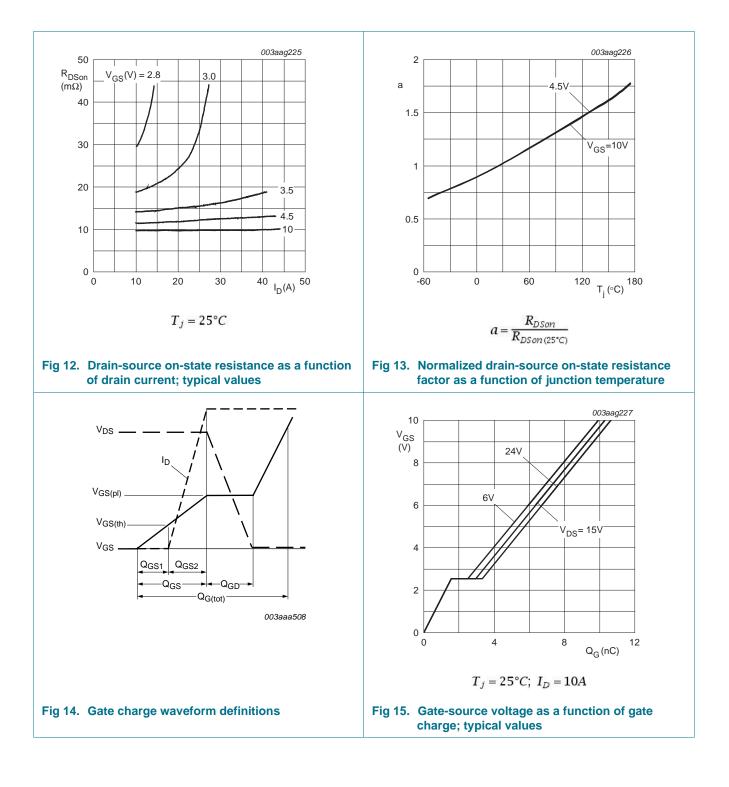
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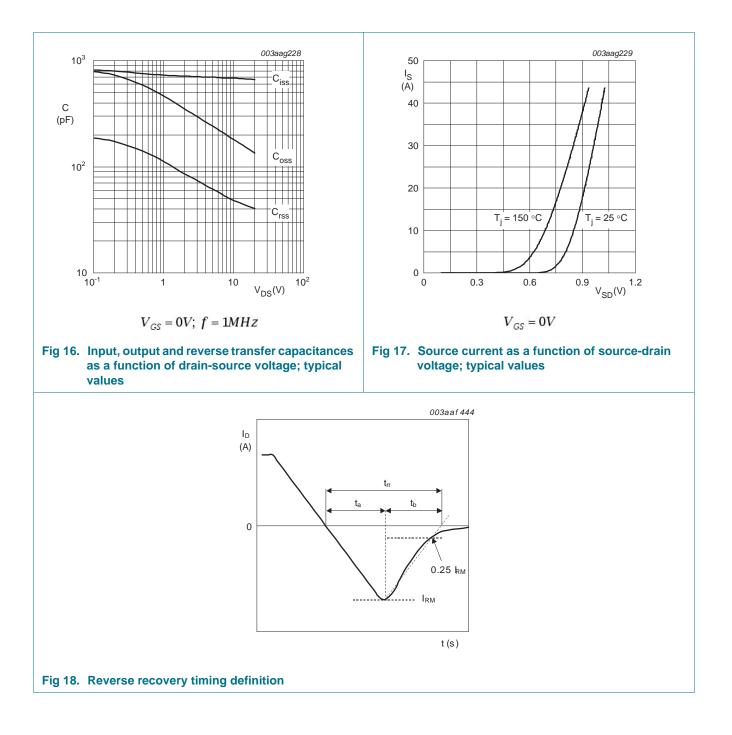


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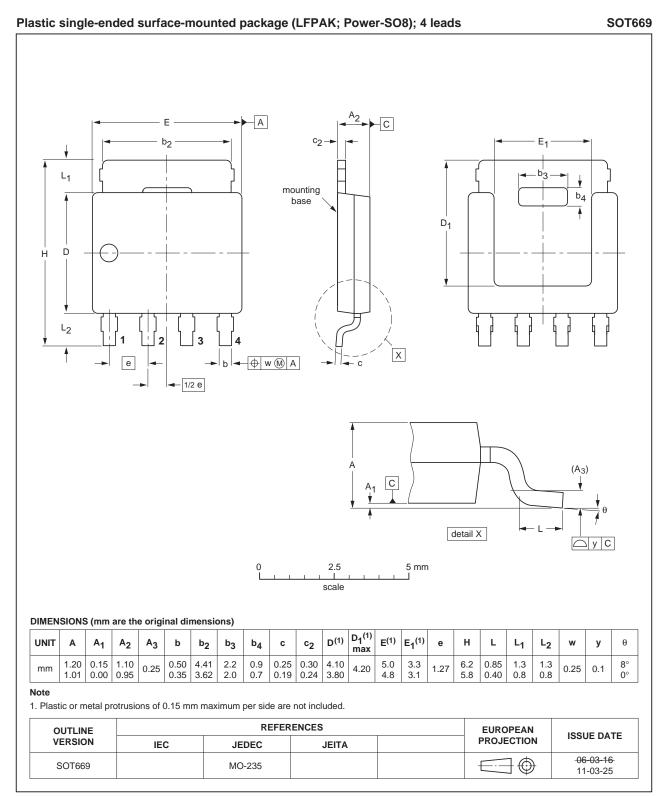


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#### N-channel 30 V 11.6 mΩ logic level MOSFET in LFPAK using NextPower technology

### 7. Package outline



#### Fig 19. Package outline SOT669 (LFPAK; Power-SO8)

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### 8. Revision history

Table 7. Revision h	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN011-30YLC v.3	20111024	Product data sheet	-	PSMN011-30YLC v.2
Modifications:	<ul> <li>Data sheet sta</li> </ul>	tus changed from prelimina	ry to product.	
	<ul> <li>Various chang</li> </ul>	es to content.		
PSMN011-30YLC v.2	20110930	Preliminary data shee	t -	PSMN011-30YLC v.1

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### 9. Legal information

#### 9.1 Data sheet status

Document status [1] [2]	Product status 3	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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